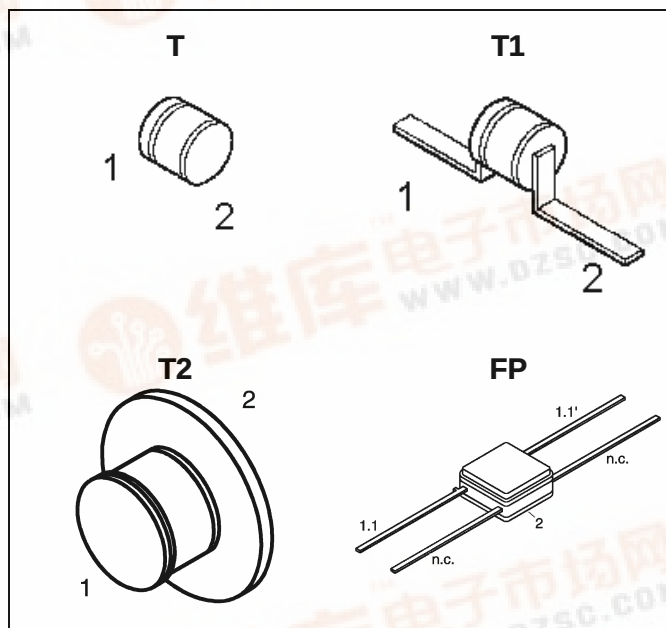
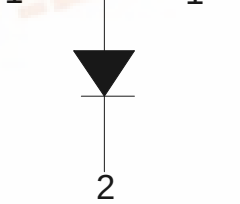


HiRel Silicon PIN Diode

- **HiRel Discrete and Microwave Semiconductor**
- Current controlled RF resistor for RF attenuators and switches
- High reverse voltage
- Hermetically sealed microwave package
-  **ESA Space Qualified**
 ESA/SCC Detail Spec. No.: 5513/030
 Type Variant No.s 04 to 07

ESD: Electrostatic discharge sensitive device,
 observe handling precautions!



Type	Marking	Ordering Code	Pin Configuration	Package
BXY44-T (ql)	-	see below		T
BXY44-T1 (ql)				T1
BXY44-T2 (ql)				T2
BXY44-FP (ql)				FP

(ql) Quality Level: P: Professional Quality,
 H: High Rel Quality,
 S: Space Quality,
 ES: ESA Space Quality,

Ordering Code: Q62702X148
 Ordering Code: on request
 Ordering Code: on request
 Ordering Code: Q62702X162

(see order instructions for ordering example)

Maximum Ratings

Parameter	Symbol	Values	Unit
Reverse Voltage	V_R	200	V
Forward Current	I_F	400	mA
Power Dissipation ¹⁾	P_{tot}	500	mW
Operating Temperature Range	T_{op}	-55 to +150	°C
Storage Temperature Range	T_{stg}	-65 to +175	°C
Soldering Temperature ²⁾	T_{sol}	+235	°C
Junction Temperature	T_j	150	°C
Thermal Resistance Junction-Case	$R_{th(j-c)}$		K/W
BXY44-T		110	
BXY44-T1		140	
BXY44-T2		110	
BXY44-FP		110	

Notes.:

- 1.) For BXY44-T; -T2, -FP: At $T_{CASE} = 95\text{ °C}$. For $T_{CASE} > 95\text{ °C}$ derating is required.
For BXY44-T1: At $T_{CASE} = 80\text{ °C}$. For $T_{CASE} > 80\text{ °C}$ derating is required.
- 2.) During 5 sec. maximum. The same terminal shall not be resoldered until 5 minutes have elapsed.

Electrical Characteristics

at $T_A=25\text{ °C}$; unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

DC Characteristics

Reverse Current 1 $V_{R1}=200V$	I_{R1}	-	-	100	nA
Reverse Current 2 $V_{R2}=100V$	I_{R2}	-	-	5	nA
Forward Voltage $I_F=100mA$	V_F	-	1,0	1,05	V

Electrical Characteristics (continued)

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Total Capacitance V _R =50V; f=1MHz BXY44-T, -T1, -T2 BXY44-FP	C _T	- -	0,20 0,50	0,35 0,75	pF
Forward Resistance 1 f=100MHz, I _{F1} =10μA BXY44-T, -T1, -T2 BXY44-FP	R _{F1}	 800 700	 900 900	 1300 1200	Ω
Forward Resistance 2 f=100MHz, I _{F2} =1mA BXY44-T, -T1, -T2 BXY44-FP	R _{F2}	 12 11	 16 20	 28 27	Ω
Forward Resistance 3 f=100MHz, I _{F3} =10mA BXY44-T, -T1, -T2 BXY44-FP	R _{F3}	 2,0 2,0	 3,0 3,8	 5,0 5,0	Ω
Minority Carrier Lifetime I _F =10mA, I _R =6mA, I _R =3mA	τ _L	300	800	-	ns

Order Instructions:

Full type variant including package variant and quality level must be specified by the orderer. For *HiRel* Discrete and Microwave Semiconductors the ordering code specifies device family and quality level only.

Ordering Form:

Ordering Code: Q.....
BXY44- (x) (ql)
(x): Package Variant
(ql): Quality Level

Ordering Example:

Ordering Code: Q62702X162
BXY44-T1 ES
For BXY44 in T1 Package; ESA Space Quality Level

Further Informations:

See our WWW-Pages:

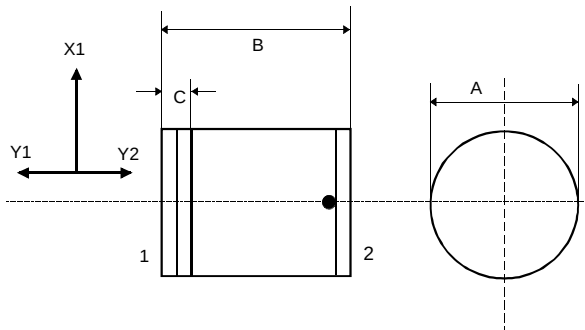
- Discrete and RF-Semiconductors (Small Signal Semiconductors)
www.infineon.com/products/discrete/hirel.htm

- *HiRel* Discrete and Microwave Semiconductors
www.infineon.com/products/discrete/hirel.htm

Please contact also our marketing division :

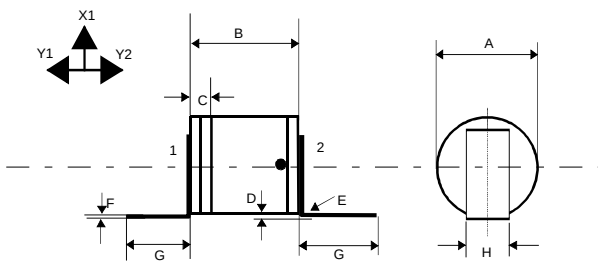
Tel.: ++89 234 24480
Fax.: ++89 234 28438
e-mail: martin.wimmers@infineon.com
Address: Infineon Technologies Semiconductors,
High Frequency Products Marketing,
P.O.Box 801709,
D-81617 Munich

T Package



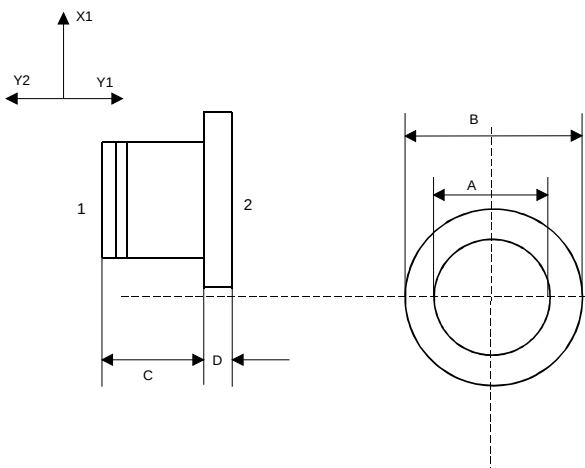
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	min	max
A	1,30	1,45
B	1,15	1,35
C	-	0,40

T1 Package



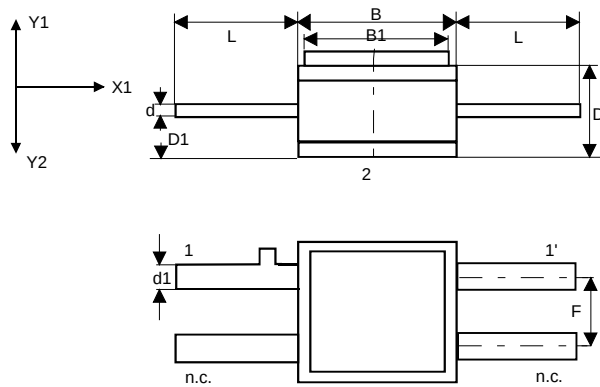
Symbol	Millimetre	
	min	max
A	1,30	1,45
B	1,15	1,35
C	-	0,40
D	0,10	0,50
E	-	0,30
F	0,06	0,10
G	5,50	-
H	0,40	0,60

T2 Package



Symbol	Millimetre	
	min	max
ØA	1,30	1,45
ØB	2,0	2,2
C	0,60	1,25
D	0,08	0,20

FP Package



Symbol	Millimetre	
	min	max
B	3,10	3,55
B1	3,00	3,30
D	1,30	1,70
D1	0,55	0,65
d	0,10	0,15
d1	0,25	0,40
F	2,40	2,60
L	5,50	-

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